## SECTION B — PERFORMING OPERATIONS; TRANSPORTING

## B33 ADDITIVE MANUFACTURING TECHNOLOGY

B33Y ADDITIVE MANUFACTURING, i.e. MANUFACTURING OF THREE-DIMENSIONAL [3D] OBJECTS BY ADDITIVE DEPOSITION, ADDITIVE AGGLOMERATION OR ADDITIVE LAYERING, e.g. BY 3D PRINTING, STEREOLITHOGRAPHY OR SELECTIVE LASER SINTERING [2015.01]

## Note(s) [2015.01]

- 1. This subclass <u>covers</u> additive manufacturing, irrespective of the process or material used.
- 2. This subclass is intended to enable a comprehensive search of subject matter related to additive manufacturing by combination of classification symbols of this subclass with classification symbols from other subclasses. Therefore, this subclass covers aspects of additive manufacturing (e.g. 3D printing) that might also be entirely or partially covered elsewhere in the IPC.
- 3. This subclass is for obligatory supplementary classification of subject matter already classified as such in other classification places, when the subject matter contains an aspect of additive manufacturing.
- 4. The classification symbols of this subclass are not listed first when assigned to patent documents.

50/00	Data acquisition or data processing for additive manufacturing [2015.01]	99/00	Subject matter not provided for in other groups of this subclass [2015.01]
40/20	<ul> <li>Post-treatment, e.g. curing, coating or polishing [2020.01]</li> </ul>	80/00	Products made by additive manufacturing [2015.01]
40/10	• Pre-treatment [2020.01]		metals and biomaterials [2020.01]
40/00	Auxiliary operations or equipment, e.g. for material handling [2015.01, 2020.01]	70/10	Composites of different types of material, e.g. mixtures of ceramics and polymers or mixtures of
50700	thereof or accessories therefor [2015.01]	70/00	Materials specially adapted for additive manufacturing [2015.01, 2020.01]
30/00	Apparatus for additive manufacturing; Details	30/02	processes [2015.01]
10/00	Processes of additive manufacturing [2015.01]	50/02	<ul> <li>for controlling or regulating additive manufacturing</li> </ul>

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